

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>MICHAEL J. SEDDON</td> <td>01/15/2010</td> </tr> <tr> <td>FRANCIS J. CARNEY</td> <td>01/15/2010</td> </tr> <tr> <td>GORDON M. GRIVNA</td> <td>01/15/2010</td> </tr> </tbody> </table>		Name	Execution Date	MICHAEL J. SEDDON	01/15/2010	FRANCIS J. CARNEY	01/15/2010	GORDON M. GRIVNA	01/15/2010
Name	Execution Date								
MICHAEL J. SEDDON	01/15/2010								
FRANCIS J. CARNEY	01/15/2010								
GORDON M. GRIVNA	01/15/2010								
RECEIVING PARTY DATA									
Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC								
Street Address:	5005 E. MCDOWELL ROAD								
City:	PHOENIX								
State/Country:	ARIZONA								
Postal Code:	85008								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14061153</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14061153				
Property Type	Number								
Application Number:	14061153								
CORRESPONDENCE DATA									
Fax Number:	(602)244-3169								
Phone:	602-244-5603								
Email:	patents@onsemi.com								
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>									
Correspondent Name:	SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC								
Address Line 1:	5005 E. MCDOWELL ROAD								
Address Line 2:	INTELLECTUAL PROPERTY DEPT.-A242								
Address Line 4:	PHOENIX, ARIZONA 85008								
ATTORNEY DOCKET NUMBER:	ONS01248F2D01								
NAME OF SUBMITTER:	LYDIA MCNAMARA								
Signature:	/Lydia McNamara/								

Date:

10/23/2013

Total Attachments: 2

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ASSIGNMENT & AGREEMENT

ATTORNEY DKT#: ONS01248F2

For good and valuable consideration, the receipt of which is hereby acknowledged, we,

<u>Name</u>	<u>of (City/State/Country)</u>
Michael J. Seddon	Gilbert, ARIZONA USA
Francis J. Carney	San Tan Valley, ARIZONA USA
Gordon M. Grivna	Mesa, ARIZONA USA

have sold, assigned, and transferred, and do hereby sell, assign, and transfer unto Semiconductor Components Industries, LLC (SCI), a limited liability Company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives, the entire right, title, and interest in and to certain inventions relating to improvements in

METHOD OF FORMING AN EM PROTECTED SEMICONDUCTOR DIE


Attorney Docket No. ONS01248F2

described, illustrated, and claimed in an application for Letters Patent of the United States of America executed by us, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation, or reissue thereof. We hereby also sell, assign, and transfer unto SCI, the entire right, title, and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the inventions and the applications for Letters Patent in foreign countries, and we further authorize SCI to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

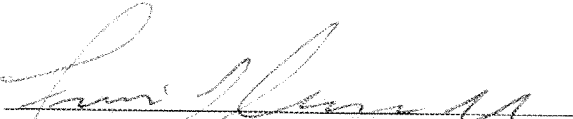
We hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation, or reissue, to SCI, for the sole use and behalf of SCI, its successors, assigns, and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by us had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to SCI.

We agree that, when requested, we will, without charge to SCI, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in SCI, its successors, assigns, and legal representatives or nominees.

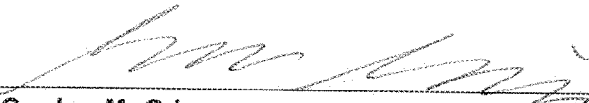
We covenant with SCI, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.



Michael J. Seddon



Francis J. Carney



Gordon M. Grivna

STATE OF ARIZONA)
 ss.:
COUNTY OF MARICOPA

I, Lydia McNamara, a Notary Public in and for the County and State aforesaid, do hereby certify that **Gordon M. Grivna, Michael J. Seddon and Francis J. Carney** whose name(s) are subscribed to the foregoing instrument, appeared before me this day in person and acknowledged that they/he/she signed, sealed and delivered the instrument as their/his/her free and voluntary act and deed for the uses and purposes therein set forth.

Given under my hand and notarial seal this 15th day of January, 210.



My commission expires on: May 7, 2010

